

SCM3406AFA Half-duplex Transceiver

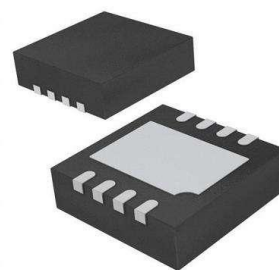
Features

- 3.0-5.5V single supply operation
- Baud Rate Up to 10Mbps
- 1/8 Unit Load—Up to 256 Nodes on a Bus
- Bus-Pin ESD Protection Up to 15 kV
- Driver short circuit protection

Applications

- Industrial Automation
- Building Automation
- Smart Electricity Meter
- Remote Signal Interaction, Transmission

Package



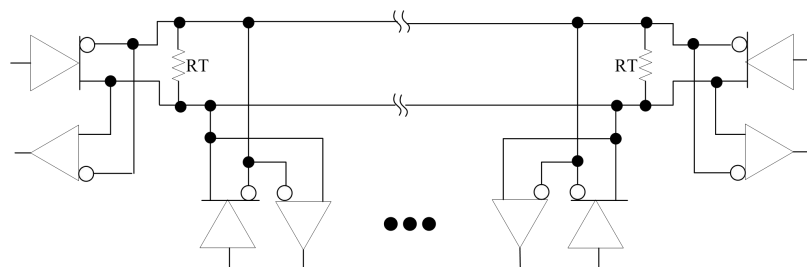
Mechanical package: DFN 3X3
(see "Ordering information" for details).

Functional Description

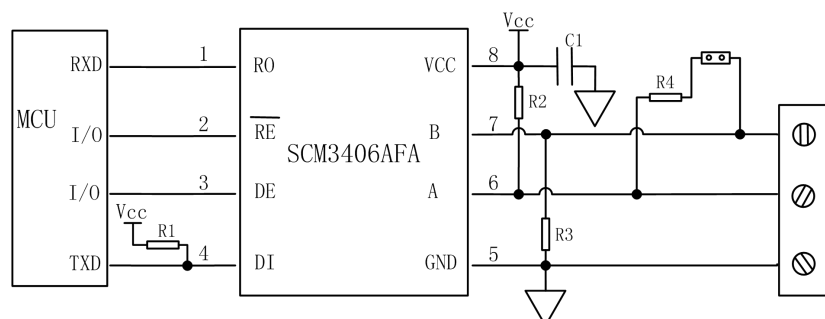
SCM3406AFA is a half-duplex enhanced transceiver designed for RS-485 data bus networks. Powered by 3.0-5.5V supply, the SCM3406AFA is fully compliant with TIA/EIA-485A standard and is suitable for data transmission of up to 10Mbps. Receivers have an exceptionally high input impedance, which places only 1/8 of the standard load on a shared bus and up to 256 transceivers.

The reliability design of A B pin is emphasized, including driver output over current protection and enhanced ESD design. The ESD protection level of A,B pin can be up to 15kV (Human Body Model).

Typical Application Circuit



Typical Circuit 1: Half-Duplex Network

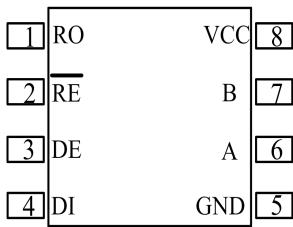


Typical Circuit 2: Application Diagram

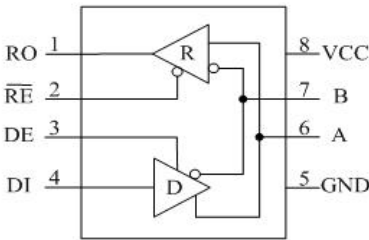
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Pin Connection



Internal Block Diagram



Function table

Driver						Receiver			
Input			Outputs			Input			Output
RE	DE	DI	A	B		RE	DE	A-B	RO
X	H	H	H	L		L	X	$\geq -40\text{mV}$	H
X	H	L	L	H		L	X	$\leq -220\text{mV}$	L
L	L	X	Z	Z		L	X	Open/Short	H
H	L	X	Z (SHUTDOWN)			H	H	X	Z
						H	L	X	Z (SHUTDOWN)

Pin descriptions

Pin Number	Pin Name	Pin Functions
1	RO	Receiver Output. When RE is low and if (A – B) $\geq -40\text{mV}$, RO is high. If (A – B) $\leq -220\text{mV}$, RO is low.
2	RE	Receiver Output Enable. When RE is low, RO is enabled. When RE is high, RO is high impedance. Drive RE high and DE low to enter shutdown mode
3	DE	Driver Output Enable. When DE is high, outputs are enabled. When DE is low, outputs are high impedance. Drive DE low and RE high to enter shutdown mode
4	DI	Driver Input
5	GND	Ground
6	A	Non-Inverting Driver Output / Receiver input
7	B	Inverting Driver Output / Receiver input
8	VCC	Positive Supply VCC. Bypass to GND with a 0.1uF capacitor

Absolute Maximum Ratings

General test conditions: Free-air, normal operating temperature range (unless otherwise specified).

Parameters	Unit
Supply voltage range, V _{CC}	-0.3V~+7V
Voltage range at A or B	-15V~+15V
Voltage range at DE, DI, $\overline{\text{RE}}$, RO	-0.3V ~ (V _{CC} + 0.3V)
Storage Temperature	-55℃~150℃
Lead Temperature (soldering, 10s)	300℃

Support ±15V in receiver mode, and -8 ~+13V in driver mode

Important: Exposure to Absolute Maximum Rated conditions for an extended period may severely affect the device reliability, and stress levels exceeding the "Absolute Maximum Ratings" may result in permanent damage.

Recommended Operating Conditions

Recommended Operating Conditions	Min.	Typ.	Max.	Unit
Supply Voltage, V _{VCC}	3	5	5.5	V
Voltage at any bus terminal (differential or common mode), V _I	-7		12	
High-level input voltage (DI, DE, $\overline{\text{RE}}$), V _{IH}	2		V _{CC}	
Low-level input voltage (DI, DE, $\overline{\text{RE}}$), V _{IL}	0		0.8	
Differential load resistance	54	60		Ω
Signaling rate			10000	kbps
Operating ambient temperature, T _A in free-air	-40		125	℃
Maximum operating junction temperature, T _J			150	℃

Electrical Characteristics

General test conditions and V_{VCC}= 5V, T_a = 25℃ (unless otherwise specified).

Parameters		Conditions		Min.	Typ.	Max.	Unit
Digital Input Signals: DI, DE, $\overline{\text{RE}}$							
Logic input thresholds		High, V_{IH}		2			V
		Low, V_{IL}				0.8	
Driver							
Differential Driver Output (V_{OD})		No Load				V_{VCC}	V
Differential Driver Output (1)		$V_{\text{in}}=3\text{V}$, $R_{\text{L}}=54\Omega$, Figure16		1.5	1.9		V
Differential Driver Output (2)		$V_{\text{in}}=5\text{V}$, $R_{\text{L}}=54\Omega$, Figure16		2.1	2.8		
Differential Driver Output (3)		$R_{\text{L}}=60\Omega$, $V_{\text{CM}} = -7 \sim 12\text{V}$, $V_{\text{CC}} = 3.0\sim 3.6\text{V}$, Figure17		1.5		V_{VCC}	
Driver Common Mode Output Voltage		Figure18		1		3	V
Change in Common Mode Output Voltage		Figure19				± 0.05	V
Driver Short Circuit Current Limit		$-7\text{V}\leq V_{\text{OUT}}\leq 12\text{V}$, Figure22				± 150	mA
Receiver							
Receiver Input Resistance		$-7\text{V}\leq V_{\text{OUT}}\leq 12\text{V}$		96			k Ω
Input Current (A, B pins)		$\text{DE}=0$, $\overline{\text{RE}}=0$ $V_{\text{VCC}}=0$ or 5.5V	$V_{\text{OUT}} = 12\text{V}$			120	μA
			$V_{\text{OUT}} = -7\text{V}$	-110		μA	
Change in magnitude of differential output voltage		$I_{\text{O}} = \pm 8 \text{ mA}$		-220		-40	mV
Receiver Input Hysteresis					70		mV
Receiver Output Voltage	V_{OH} , Figure 23	$I_{\text{OUT}} = -8\text{mA}$, $V_{\text{CC}} = 4.5\text{V} \sim 5.5\text{V}$ $V_{\text{ID}}= 1$		3	4.5		V
	V_{OH} , Figure 23	$I_{\text{OUT}} = -8\text{mA}$, $V_{\text{CC}} = 3.0\text{V} \sim 3.6\text{V}$ $V_{\text{ID}}= 1\text{V}$		2.45	2.65		
	V_{OL} , Figure 23	$I_{\text{OUT}} = 8\text{mA}$, $V_{\text{CC}} = 4.5\text{V} \sim 5.5\text{V}$ $V_{\text{ID}}= -1\text{V}$				0.4	

	V_{OL} , Figure 23	$I_{OUT} = 8mA, V_{CC} = 3.0V \sim 3.6V$ $VID = -1V$			0.5	
Supply and Protection						
I_{VCC}	Driver and receiver enabled	$DE = V_{VCC}, \overline{RE} = 0$, No load		1900	2200	μA
	Driver enabled, receiver disabled	$DE = V_{VCC}, \overline{RE} = V_{VCC}$, No load		1800	2200	μA
	Receiver enabled, driver disabled	$DE = V_{VCC}, \overline{RE} = 0$, No load		1700	2000	μA
	Driver and receiver disabled	$DE = 0, \overline{RE} = V_{VCC}$, No load		1650	2000	μA
ESD	Human Body Model	A, B and GND		± 15		kV
		Other pins		± 4		kV
	IEC61000-4-2	A, B and GND		± 15		kV
EFT	IEC61000-4-4	A, B and GND		± 1		kV

Transmission Characteristics

General test conditions and $V_{VCC} = 5V, T_a = 25^{\circ}C$ (unless otherwise specified).

Parameters	Conditions	Min.	Typ.	Max.	Unit
Driver					
Data Signaling Rate	Duty Cycle 40% ~ 60%			10000	kbps
Driver Propagation Delay (T_{PHL},T_{PLH})	$R_L = 54\Omega, C_L = 50pF$, Figure 19		21	30	nS
Driver Output Rise/Fall Time (T_R,T_F)			8		nS
Driver Differential Skew ($ T_{PHL} - T_{PLH} $)			3	6	nS
Driver Enable to Output High (T_{PZH})	$R_L=110\Omega, \overline{RE} = 0$,Figure 20, Figure 21		20	45	nS
Driver Enable to Output Low (T_{PZL})			30	50	nS
Driver Disable from Output High (T_{PHZ})			30	50	nS
Driver Disable from Output Low (T_{PLZ})			30	50	nS
Receiver					
Receiver Propagation Delay (T_{PLH},T_{PHL})	$C_L = 15pF$, Figure 22		35	50	nS
Receiver Differential Skew ($ T_{PLH} - T_{PHL} $)			10	15	nS
Receiver Output Rise/Fall Time (T_R,T_F)	$C_L = 15pF, V_{DI}=-1.5V\sim 1.5V$, Figure 22		14		nS
Receiver Enable to Output High (T_{PZH})	$C_L = 15pF$, Figure 23, Figure 24		20	30	nS
Receiver Enable to Output Low (T_{PZL})			25	40	nS
Receiver Disable from Output High (T_{PHZ})			30	60	nS
Receiver Disable from Output Low (T_{PLZ})			30	60	nS

Typical Performance Curves

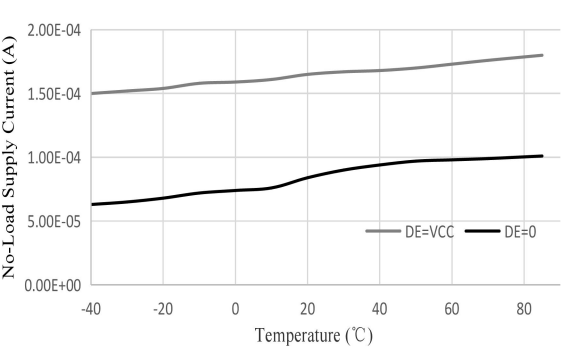


Figure 1 No-Load Supply Current vs. Temperature

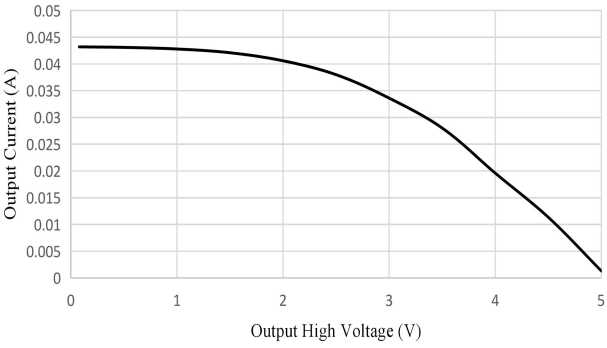


Figure 2 Output Current vs. Receiver Output High Voltage

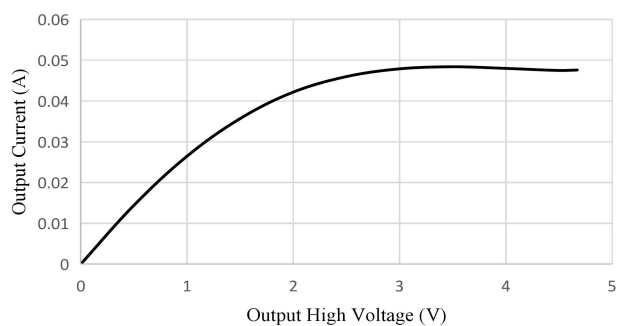


Figure 3 Output Current vs. Receiver Output Low Voltage

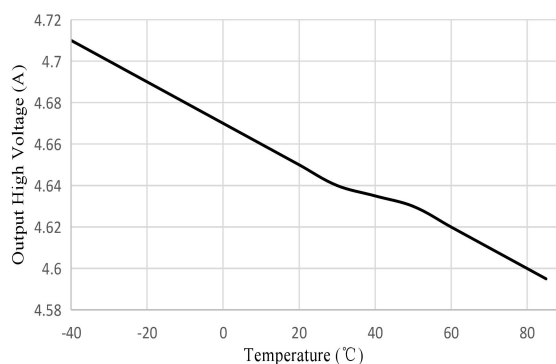


Figure 4 Receiver Output High Voltage vs. Temperature

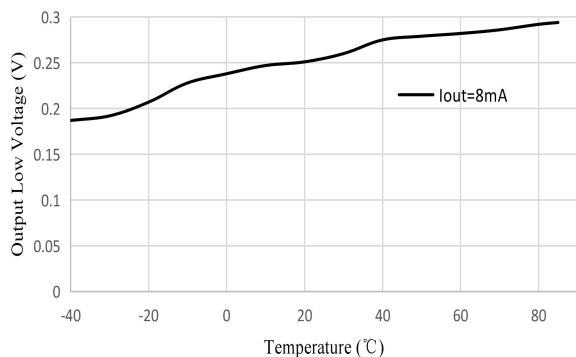


Figure 5 Receiver output low voltage vs. Temperature

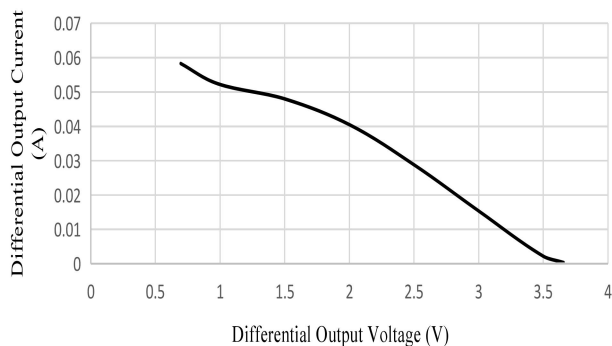


Figure 6 Driver differential output current vs. Differential output voltage

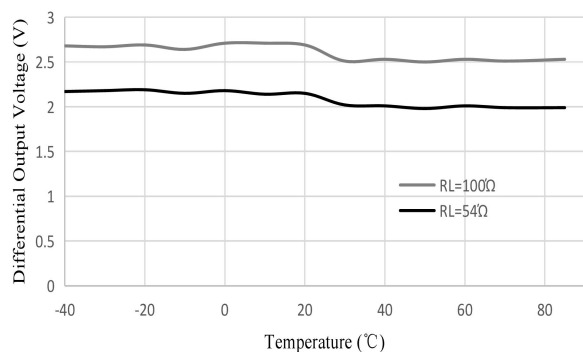


Figure 7 Driver Differential Output Voltage vs Temperature

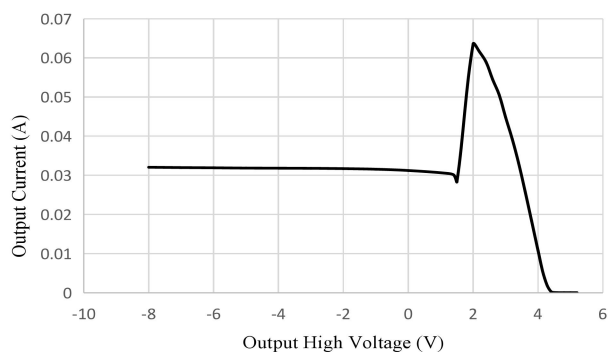


Figure 8 Output current vs. Transmitter output high voltage

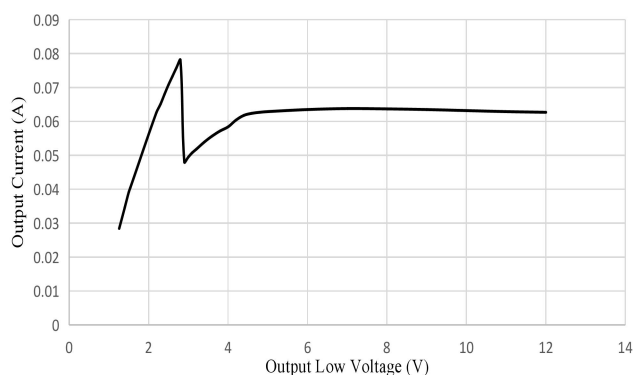


Figure 9 Output current vs. Transmitter output low voltage

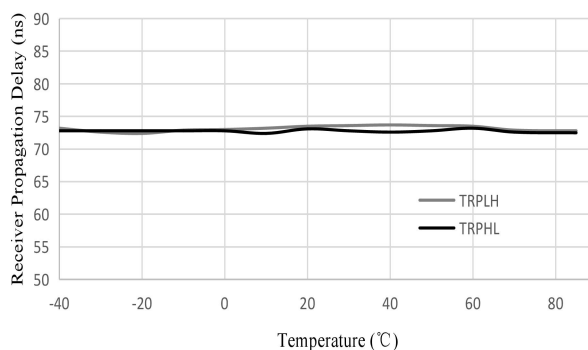


Figure 10 Receiver Propagation Delay vs. Temperature

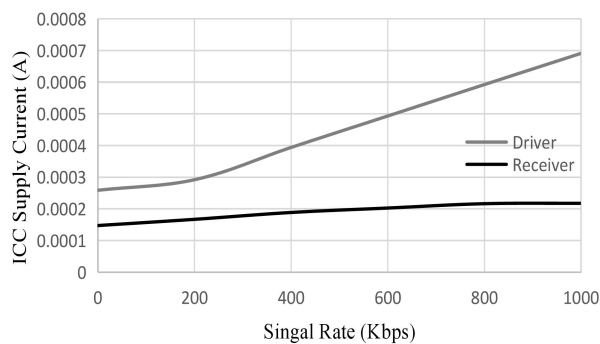


Figure 11 RMS Supply Current vs. Signaling Rate

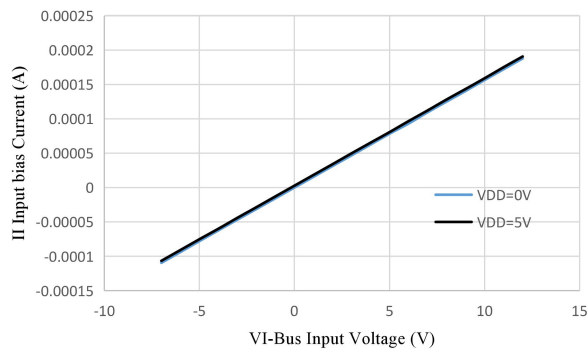


Figure 13 Bus input current vs. Bus input voltage

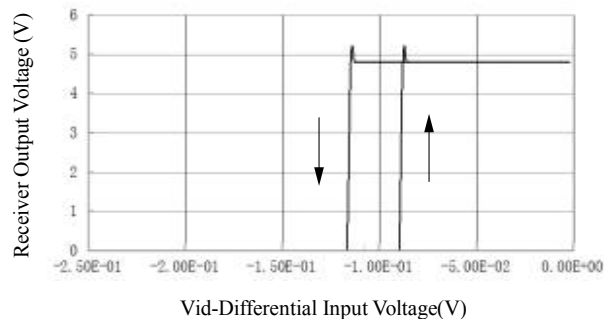


Figure 12 Receiver output voltage vs. Differential input voltage

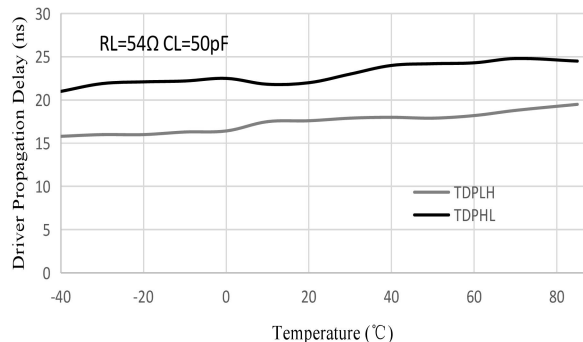


Figure 14 Driver propagation delay vs. Temperature

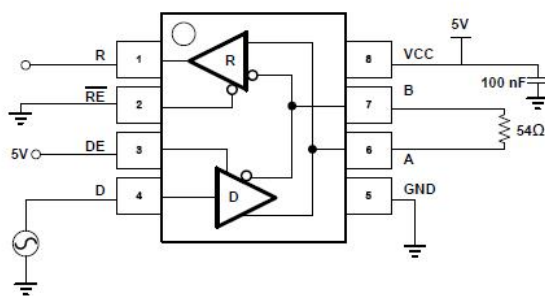
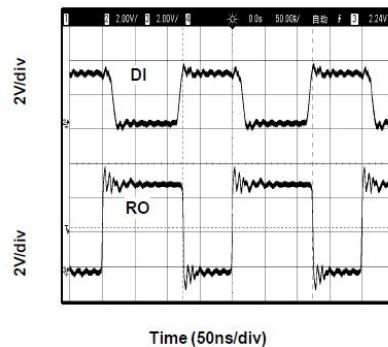


Figure 15 Loop back Test Circuit



Time (50ns/div)

Test Circuits

Note: Load test capacitance includes probe and test fixture stray capacitance, unless otherwise specified. Signal generator with following characteristics: Rise and fall time < 6ns, pulse rate 100kHz, 50% duty cycle, $Z_0 = 50\Omega$ (unless otherwise specified).

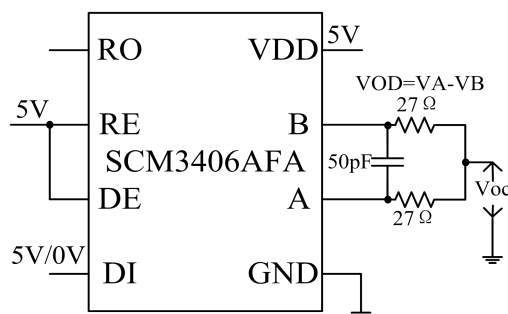


Figure 16 Driver Test Circuit, V_{OD} and V_{OC} Without Common-Mode Loading

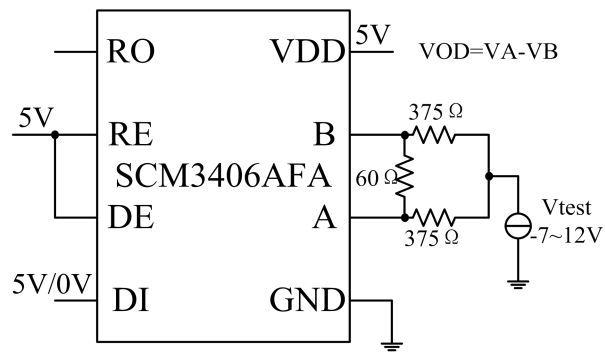


Figure 17 Driver Test Circuit, V_{OD} With Common-Mode Loading

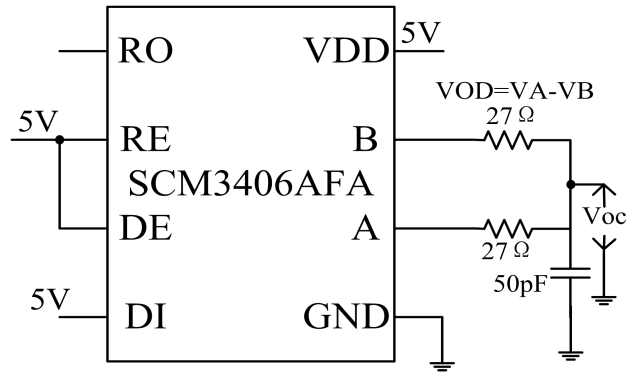


Figure 18 Driver V_{OC} Test Circuit

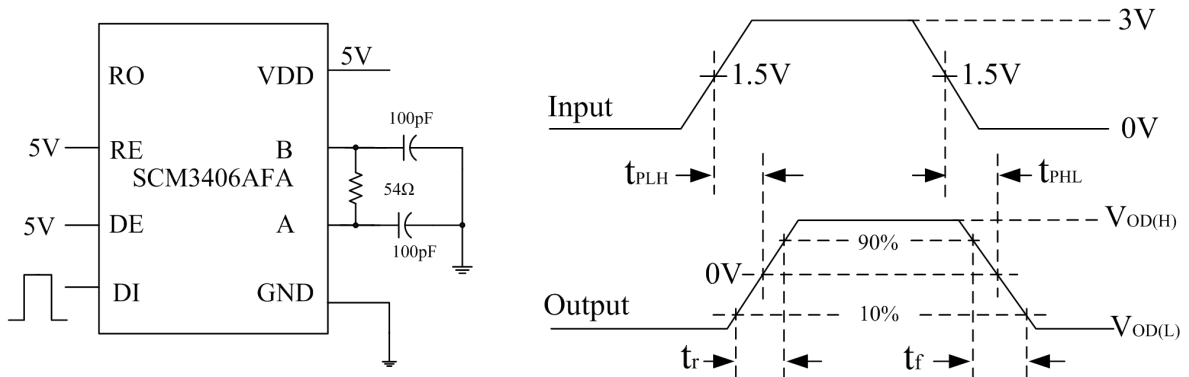


Figure 19 Driver Switching Test Circuit and Waveforms

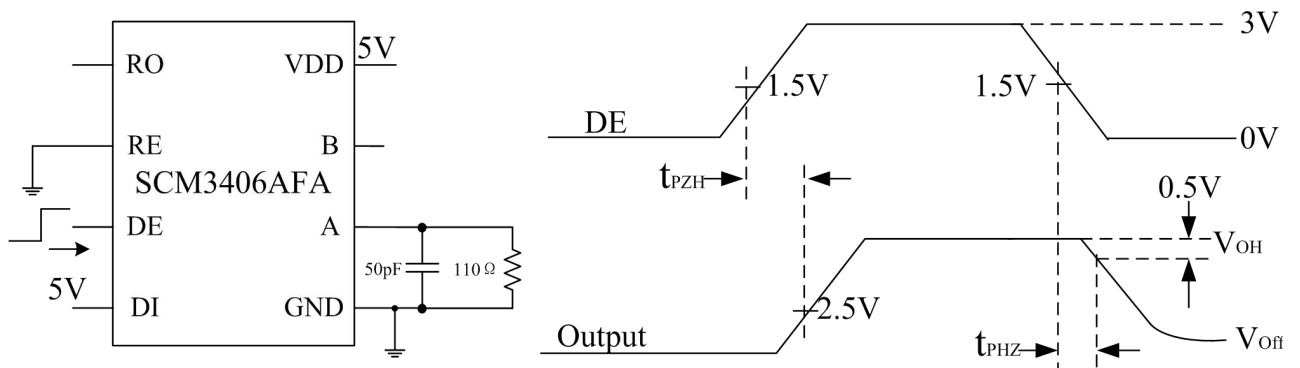


Figure 20 Driver Enable/Disable Test Circuit and Waveforms, High Output

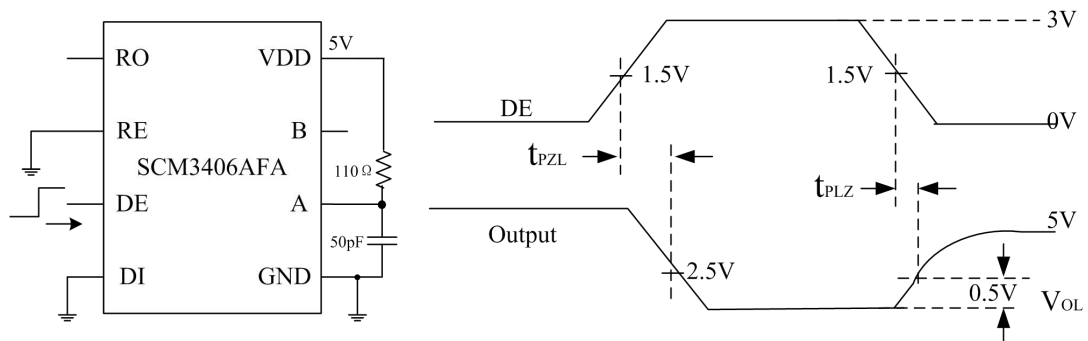


Figure 21 Driver Enable/Disable Test Circuit and Waveforms, Low Output

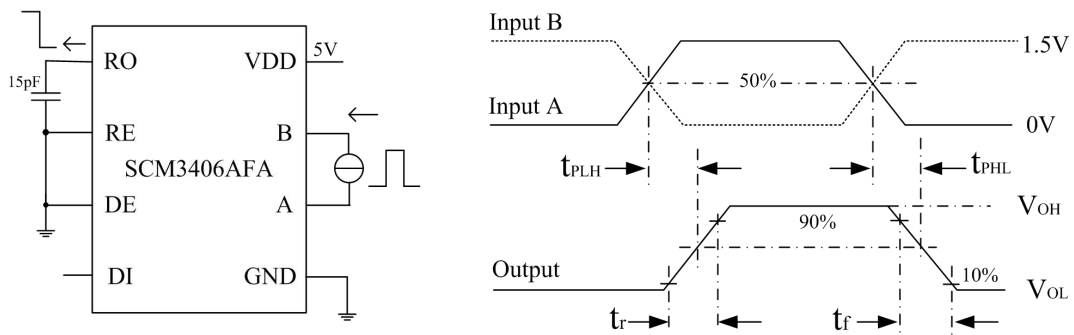


Figure 22 Receiver Switching Test Circuit and Waveforms

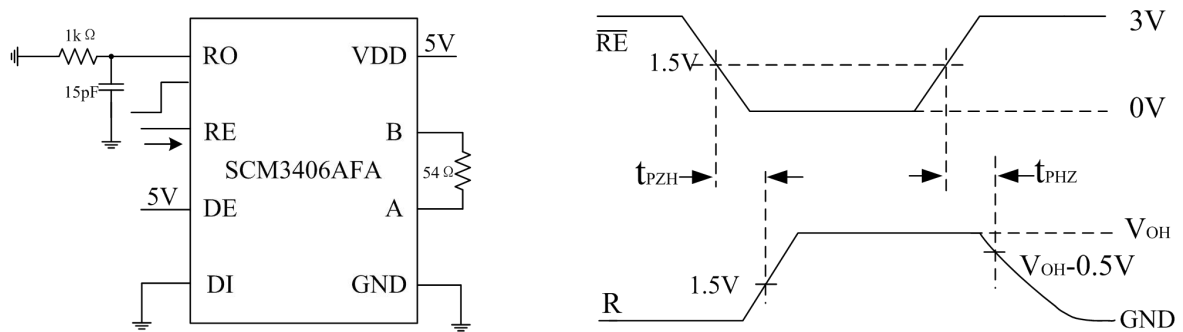


Figure 23 Receiver Enable/Disable Test Circuit and Waveforms, Data Output High

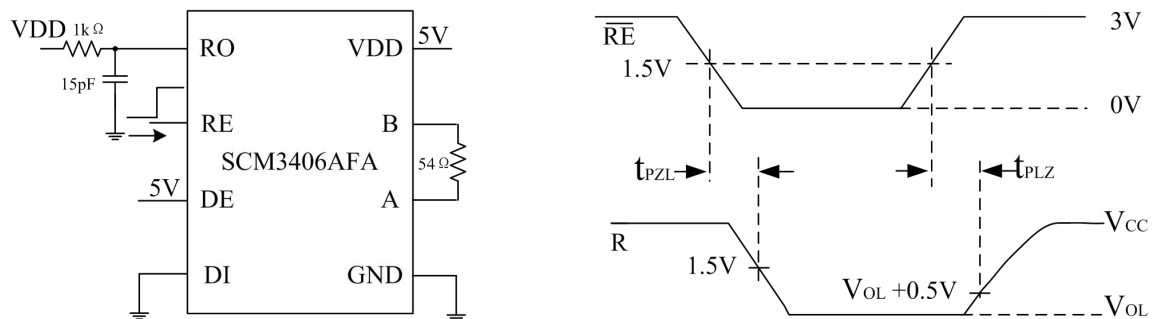


Figure 24 Receiver Enable/Disable Test Circuit and Waveforms, Data Output Low

Suggestions for Power Supply

If the input power is a few inches from the SCM3406AFA, as much as possible, connect a 0.1μF bypass capacitor to the V_{CC} pin and a 10μF capacitor near the center tap pin of the transformer.

Ordering Information

Part number	Package	Number of pins	Product Marking
SCM3406AFA	DFN	8	3406AFA YM

Description of product code

SCM3406AFAXYZ :

- (1) SCM3406AFA, product code.
- (2) X = A-Z, version code.
- (3) Y = F encapsulation code; F: DFN encapsulation.
- (4) Z = C, I, A, M, temperature grade code; C: 0℃-70℃, I:-40℃-85℃, A:-40℃-125℃, M:-55℃-125℃.

Product marking:

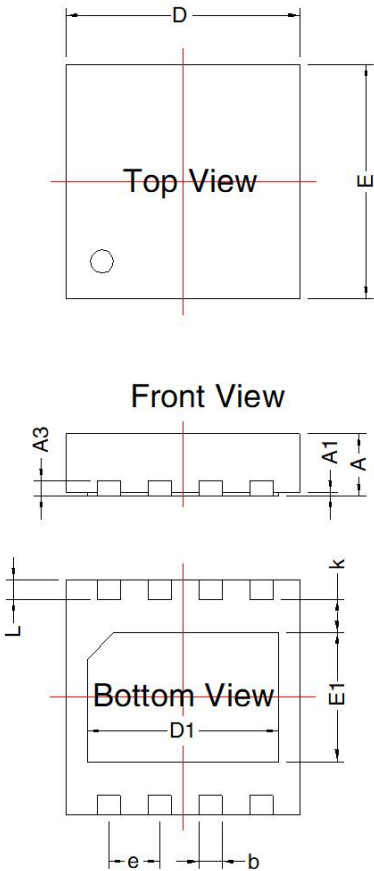
3406X

YM

(1) X = A-Z, version code

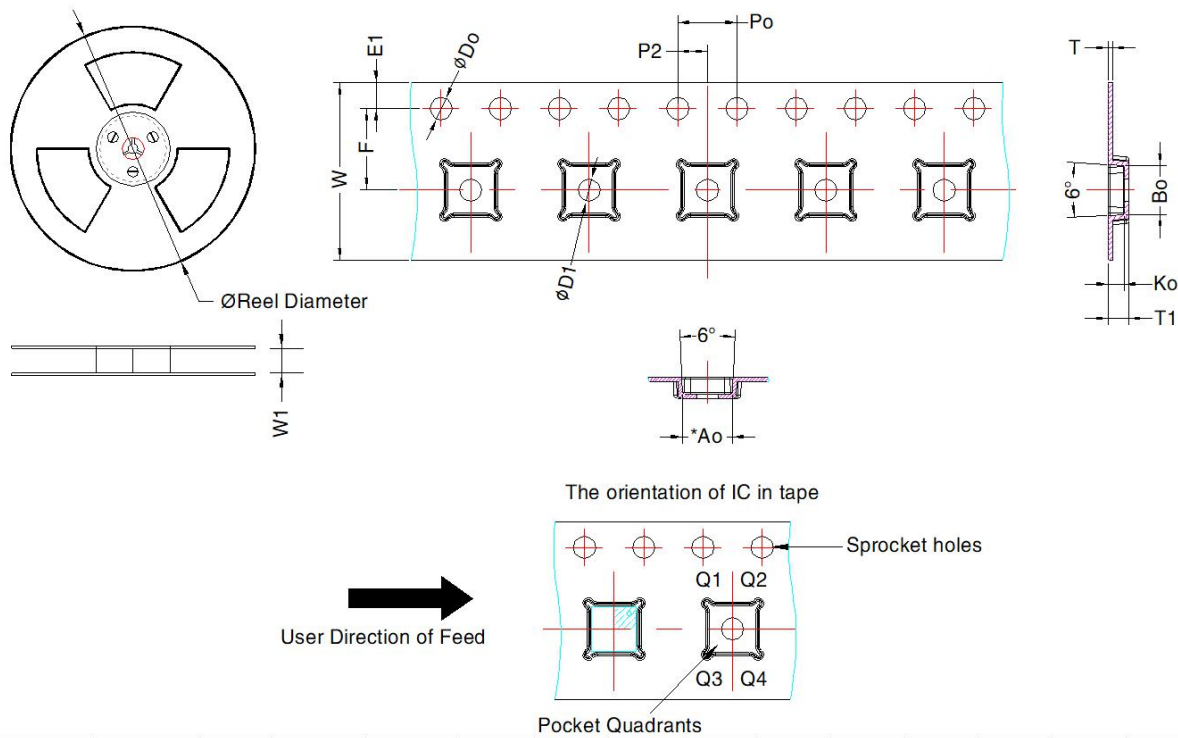
(2) YM: Product traceability code; Y: Code of product production year, M: Code of product production month

Package Information



THIRD ANGLE PROJECTION

Mark	Dimension(mm)		Dimension(inch)	
	Min	Max	Min	Max
A	0.70	0.80	0.028	0.031
A1	0	0.05	0	0.002
A3	0.203REF		0.008REF	
D	3.00 BSC.		0.118BSC.	
D1	2.20	2.40	0.087	0.094
E	3.00 BSC.		0.118BSC.	
E1	1.40	1.60	0.055	0.063
L	0.224	0.376	0.009	0.015
e	0.65TYP		0.026TYP	
b	0.25	0.35	0.001	0.014
k	0.25MIN		0.010MIN	



Device	Package Type	MPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	T (mm)	W (mm)	E (mm)	F (mm)	P1 (mm)	P0 (mm)	D0 (mm)	D1 (mm)	Pin1 Quadrant
SCM3406AFA	DFN 3x3	6100	330.0	12.4	3.34 ± 0.1	3.34 ± 0.1	1.10 ± 0.1	0.30 ± 0.05	12.0 ± 0.3	1.75 ± 0.1	5.5 ± 0.1	8.0 ± 0.1	4.0 ± 0.1	1.5 ± 0.1	1.5 ± 0.1	Q2

Note: Minimum order quantity is the minimum packing quantity the order quantity is the integer times of MPQ

Technical requirement:

- Color : Blue (Reference color number:
PANTONE DS 196-1 C: C100 M70 Y0 K0
PANTONE DS 197-1 C: C100 M70 Y0 K10
PANTONE DS 205-1 C: C100 M60 Y0 K20
PANTONE DS 205-2 C: C85 M50 Y0 K20
PANTONE DS 206-2 C: C85 M50 Y0 K35
PANTONE DS 219-1 C: C90 M50 Y5 K15)
- Dimensions and tolerances according to ANSI/EIA-481-C-2003;
- Disk surface good finish, no warping deformation;
- External packing in good condition, no damage or pollution.

MORNSUN Guangzhou Science & Technology Co., Ltd.

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